

High-Speed CMOS Logic 8-Stage Synchronous Down Counters

Features

- Synchronous or Asynchronous Preset
- Cascadable in Synchronous or Ripple Mode
- Fanout (Over Temperature Range)
 - Standard Outputs 10 LSTTL Loads
 - Bus Driver Outputs 15 LSTTL Loads
- Wide Operating Temperature Range . . . -55°C to 125°C
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
 - 2V to 6V Operation
 - High Noise Immunity: $N_{IL} = 30\%$, $N_{IH} = 30\%$ of V_{CC} at $V_{CC} = 5V$
- HCT Types
 - 4.5V to 5.5V Operation
 - Direct LSTTL Input Logic Compatibility, $V_{IL} = 0.8V$ (Max), $V_{IH} = 2V$ (Min)
 - CMOS Input Compatibility, $I_I \leq 1\mu A$ at V_{OL} , V_{OH}

Ordering Information

| PART NUMBER | TEMP. RANGE (°C) | PACKAGE |
|-----------------|------------------|--------------|
| CD54HC40103F3A | -55 to 125 | 16 Ld CERDIP |
| CD74HC40103E | -55 to 125 | 16 Ld PDIP |
| CD74HC40103M | -55 to 125 | 16 Ld SOIC |
| CD74HC40103MT | -55 to 125 | 16 Ld SOIC |
| CD74HC40103M96 | -55 to 125 | 16 Ld SOIC |
| CD74HCT40103E | -55 to 125 | 16 Ld PDIP |
| CD74HCT40103M | -55 to 125 | 16 Ld SOIC |
| CD74HCT40103MT | -55 to 125 | 16 Ld SOIC |
| CD74HCT40103M96 | -55 to 125 | 16 Ld SOIC |

NOTE: When ordering, use the entire part number. The suffix 96 denotes tape and reel. The suffix T denotes a small-quantity reel of 250.

Description

The 'HC40103 and CD74HCT40103 are manufactured with high speed silicon gate technology and consist of an 8-stage synchronous down counter with a single output which is active when the internal count is zero. The 40103 contains a single 8-bit binary counter. Each has control inputs for enabling or disabling the clock, for clearing the counter to its maximum count, and for presetting the counter either synchronously or asynchronously. All control inputs and the \overline{TC} output are active-low logic.

In normal operation, the counter is decremented by one count on each positive transition of the CLOCK (CP). Counting is inhibited when the \overline{TE} input is high. The \overline{TC} output goes low when the count reaches zero if the \overline{TE} input is low, and remains low for one full clock period.

When the \overline{PE} input is low, data at the P0-P7 inputs are clocked into the counter on the next positive clock transition regardless of the state of the \overline{TE} input. When the \overline{PL} input is low, data at the P0-P7 inputs are asynchronously forced into the counter regardless of the state of the \overline{PE} , \overline{TE} , or CLOCK inputs. Input P0-P7 represent a single 8-bit binary word for the 40103. When the MR input is low, the counter is asynchronously cleared to its maximum count of 255₁₀, regardless of the state of any other input. The precedence relationship between control inputs is indicated in the truth table.

If all control inputs except \overline{TE} are high at the time of zero count, the counters will jump to the maximum count, giving a counting sequence of 100₁₆ or 256₁₀ clock pulses long.

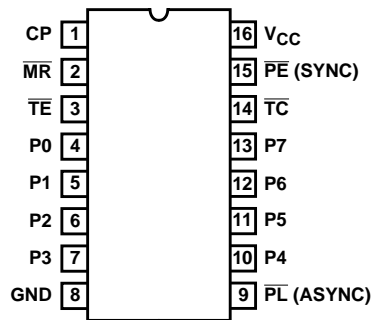
The 40103 may be cascaded using the \overline{TE} input and the \overline{TC} output, in either a synchronous or ripple mode. These circuits possess the low power consumption usually associated with CMOS circuitry, yet have speeds comparable to low power Schottky TTL circuits and can drive up to 10 LSTTL loads.



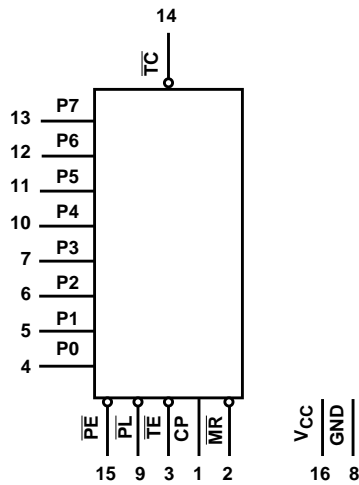
CD54HC40103, CD74HC40103, CD74HCT40103

Pinout

CD54HC40103
(CERDIP)
CD74HC40103, CD74HCT40103
(PDIP, SOIC)
TOP VIEW



Functional Diagram



TRUTH TABLE

| CONTROL INPUTS | | | | PRESET MODE | ACTION |
|----------------|----|----|----|----------------|--|
| MR | PL | PE | TE | | |
| 1 | 1 | 1 | 1 | Synchronous | Inhibit Counter |
| 1 | 1 | 1 | 0 | | Count Down |
| 1 | 1 | 0 | X | | Preset On Next Positive Clock Transition |
| 1 | 0 | X | X | Asynchronously | Preset Asynchronously |
| 0 | X | X | X | | Clear to Maximum Count |

1 = High Level.

0 = Low Level.

X = Don't Care.

Clock connected to clock input.

Synchronous Operation: changes occur on negative-to-positive clock transitions.

Load Inputs: MSB = P7, LSB = P0.

CD54HC40103, CD74HC40103, CD74HCT40103

Absolute Maximum Ratings

| | |
|--|-------------|
| DC Supply Voltage, V_{CC} | -0.5V to 7V |
| DC Input Diode Current, I_{IK} | |
| For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$ | $\pm 20mA$ |
| DC Output Diode Current, I_{OK} | |
| For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ | $\pm 20mA$ |
| DC Output Source or Sink Current per Output Pin, I_O | |
| For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$ | $\pm 25mA$ |
| DC V_{CC} or Ground Current, I_{CC} | $\pm 50mA$ |

Thermal Information

| | |
|--|--|
| Thermal Resistance (Typical, Note 1) | θ_{JA} ($^{\circ}C/W$) |
| E (PDIP) Package | 67 |
| M (SOIC) Package | 73 |
| Maximum Junction Temperature | 150 $^{\circ}C$ |
| Maximum Storage Temperature Range | -65 $^{\circ}C$ to 150 $^{\circ}C$ |
| Maximum Lead Temperature (Soldering 10s) | 300 $^{\circ}C$ (SOIC - Lead Tips Only) |

Operating Conditions

| | |
|---|------------------------------------|
| Temperature Range, T_A | -55 $^{\circ}C$ to 125 $^{\circ}C$ |
| Supply Voltage Range, V_{CC} | |
| HC Types | 2V to 6V |
| HCT Types | 4.5V to 5.5V |
| DC Input or Output Voltage, V_I , V_O | 0V to V_{CC} |
| Input Rise and Fall Time | |
| 2V | 1000ns (Max) |
| 4.5V | 500ns (Max) |
| 6V | 400ns (Max) |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

- The package thermal impedance is calculated in accordance with JESD 51-7.

DC Electrical Specifications

| PARAMETER | SYMBOL | TEST CONDITIONS | | V_{CC} (V) | 25 $^{\circ}C$ | | | -40 $^{\circ}C$ TO 85 $^{\circ}C$ | | -55 $^{\circ}C$ TO 125 $^{\circ}C$ | | UNITS |
|---|----------|----------------------|------------|--------------|----------------|-----|-----------|-----------------------------------|---------|------------------------------------|---------|---------|
| | | V_I (V) | I_O (mA) | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| HC TYPES | | | | | | | | | | | | |
| High Level Input Voltage | V_{IH} | - | - | 2 | 1.5 | - | - | 1.5 | - | 1.5 | - | V |
| | | | | 4.5 | 3.15 | - | - | 3.15 | - | 3.15 | - | V |
| | | | | 6 | 4.2 | - | - | 4.2 | - | 4.2 | - | V |
| Low Level Input Voltage | V_{IL} | - | - | 2 | - | - | 0.5 | - | 0.5 | - | 0.5 | V |
| | | | | 4.5 | - | - | 1.35 | - | 1.35 | - | 1.35 | V |
| | | | | 6 | - | - | 1.8 | - | 1.8 | - | 1.8 | V |
| High Level Output Voltage CMOS Loads | V_{OH} | V_{IH} or V_{IL} | -0.02 | 2 | 1.9 | - | - | 1.9 | - | 1.9 | - | V |
| | | | -0.02 | 4.5 | 4.4 | - | - | 4.4 | - | 4.4 | - | V |
| | | | -0.02 | 6 | 5.9 | - | - | 5.9 | - | 5.9 | - | V |
| High Level Output Voltage TTL Loads | V_{OH} | V_{IH} or V_{IL} | - | - | - | - | - | - | - | - | - | V |
| | | | -4 | 4.5 | 3.98 | - | - | 3.84 | - | 3.7 | - | V |
| | | | -5.2 | 6 | 5.48 | - | - | 5.34 | - | 5.2 | - | V |
| Low Level Output Voltage CMOS Loads | V_{OL} | V_{IH} or V_{IL} | 0.02 | 2 | - | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 0.02 | 4.5 | - | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 0.02 | 6 | - | - | 0.1 | - | 0.1 | - | 0.1 | V |
| Low Level Output Voltage TTL Loads | V_{OL} | V_{IH} or V_{IL} | - | - | - | - | - | - | - | - | - | V |
| | | | 4 | 4.5 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| | | | 5.2 | 6 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| Input Leakage Current | I_I | V_{CC} or GND | - | 6 | - | - | ± 0.1 | - | ± 1 | - | ± 1 | μA |
| Quiescent Device Current | I_{CC} | V_{CC} or GND | 0 | 6 | - | - | 8 | - | 80 | - | 160 | μA |

CD54HC40103, CD74HC40103, CD74HCT40103

DC Electrical Specifications (Continued)

| PARAMETER | SYMBOL | TEST CONDITIONS | | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|--|---------------------------|------------------------------------|---------------------|---------------------|------|-----|------|---------------|------|----------------|-----|-------|
| | | V _I (V) | I _O (mA) | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| HCT TYPES | | | | | | | | | | | | |
| High Level Input Voltage | V _{IH} | - | - | 4.5 to 5.5 | 2 | - | - | 2 | - | 2 | - | V |
| Low Level Input Voltage | V _{IL} | - | - | 4.5 to 5.5 | - | - | 0.8 | - | 0.8 | - | 0.8 | V |
| High Level Output Voltage CMOS Loads | V _{OH} | V _{IH} or V _{IL} | -0.02 | 4.5 | 4.4 | - | - | 4.4 | - | 4.4 | - | V |
| High Level Output Voltage TTL Loads | | | -4 | 4.5 | 3.98 | - | - | 3.84 | - | 3.7 | - | V |
| Low Level Output Voltage CMOS Loads | V _{OL} | V _{IH} or V _{IL} | 0.02 | 4.5 | - | - | 0.1 | - | 0.1 | - | 0.1 | V |
| Low Level Output Voltage TTL Loads | | | 4 | 4.5 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| Input Leakage Current | I _I | V _{CC} and GND | 0 | 5.5 | - | - | ±0.1 | - | ±1 | - | ±1 | μA |
| Quiescent Device Current | I _{CC} | V _{CC} or GND | 0 | 5.5 | - | - | 8 | - | 80 | - | 160 | μA |
| Additional Quiescent Device Current Per Input Pin: 1 Unit Load | ΔI _{CC} (Note 2) | V _{CC} -2.1 | - | 4.5 to 5.5 | - | 100 | 360 | - | 450 | - | 490 | μA |

NOTE:

- For dual-supply systems theoretical worst case (V_I = 2.4V, V_{CC} = 5.5V) specification is 1.8mA.

HCT Input Loading Table

| INPUT | UNIT LOADS (NOTE) |
|-----------------------------------|-------------------|
| P0-P7 | 0.20 |
| \overline{TE} , \overline{MR} | 0.40 |
| CP | 0.60 |
| PE | 0.80 |
| \overline{PL} | 1.35 |

NOTE: Unit Load is ΔI_{CC} limit specified in DC Electrical Table, e.g., 360μA max at 25°C.

Prerequisite for Switching Specifications

| PARAMETER | SYMBOL | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|-----------------------------|----------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
| | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| HC TYPES | | | | | | | | | | |
| CP Pulse Width | t _w | 2 | 165 | - | - | 205 | - | 250 | - | ns |
| | | 4.5 | 33 | - | - | 41 | - | 50 | - | ns |
| | | 6 | 28 | - | - | 35 | - | 43 | - | ns |
| \overline{PL} Pulse Width | t _w | 2 | 125 | - | - | 155 | - | 190 | - | ns |
| | | 4.5 | 25 | - | - | 31 | - | 38 | - | ns |
| | | 6 | 21 | - | - | 26 | - | 32 | - | ns |

CD54HC40103, CD74HC40103, CD74HCT40103

Prerequisite for Switching Specifications (Continued)

| PARAMETER | SYMBOL | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|----------------------------|----------------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
| | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| MR Pulse Width | t _W | 2 | 125 | - | - | 135 | - | 190 | - | ns |
| | | 4.5 | 25 | - | - | 31 | - | 38 | - | ns |
| | | 6 | 21 | - | - | 26 | - | 32 | - | ns |
| CP Max. Frequency (Note 3) | f _{CP(MAX)} | 2 | 3 | - | - | 2 | - | 2 | - | MHz |
| | | 4.5 | 15 | - | - | 12 | - | 10 | - | MHz |
| | | 6 | 18 | - | - | 14 | - | 12 | - | MHz |
| P to CP Set-up Time | t _{SU} | 2 | 100 | - | - | 125 | - | 150 | - | ns |
| | | 4.5 | 20 | - | - | 25 | - | 30 | - | ns |
| | | 6 | 17 | - | - | 21 | - | 26 | - | ns |
| PE to CP Set-up Time | t _{SU} | 2 | 75 | - | - | 95 | - | 110 | - | ns |
| | | 4.5 | 15 | - | - | 19 | - | 22 | - | ns |
| | | 6 | 13 | - | - | 16 | - | 19 | - | ns |
| TE to CP Set-up Time | t _{SU} | 2 | 150 | - | - | 190 | - | 225 | - | ns |
| | | 4.5 | 30 | - | - | 38 | - | 45 | - | ns |
| | | 6 | 26 | - | - | 33 | - | 38 | - | ns |
| P to CP Hold Time | t _H | 2 | 5 | - | - | 5 | - | 5 | - | ns |
| | | 4.5 | 5 | - | - | 5 | - | 5 | - | ns |
| | | 6 | 5 | - | - | 5 | - | 5 | - | ns |
| TE to CP Hold Time | t _H | 2 | 0 | - | - | 0 | - | 0 | - | ns |
| | | 4.5 | 0 | - | - | 0 | - | 0 | - | ns |
| | | 6 | 0 | - | - | 0 | - | 0 | - | ns |
| MR to CP Removal Time | t _{REM} | 2 | 50 | - | - | 65 | - | 75 | - | ns |
| | | 4.5 | 10 | - | - | 13 | - | 15 | - | ns |
| | | 6 | 9 | - | - | 11 | - | 13 | - | ns |
| PE to CP Hold Time | t _H | 2 | 2 | - | - | 2 | - | 2 | - | ns |
| | | 4.5 | 2 | - | - | 2 | - | 2 | - | ns |
| | | 6 | 2 | - | - | 2 | - | 2 | - | ns |
| HCT TYPES | | | | | | | | | | |
| CP Pulse Width | t _W | 4.5 | 35 | - | - | 44 | - | 53 | - | ns |
| PL Pulse Width | t _W | 4.5 | 43 | - | - | 54 | - | 65 | - | ns |
| MR Pulse Width | t _W | 4.5 | 35 | - | - | 44 | - | 53 | - | ns |
| CP Max. Frequency (Note 3) | f _{CP(MAX)} | 4.5 | 14 | - | - | 11 | - | 9 | - | MHz |
| P to CP Set-up Time | t _{SU} | 4.5 | 24 | - | - | 30 | - | 36 | - | ns |
| PE to CP Set-up Time | t _{SU} | 4.5 | 20 | - | - | 25 | - | 30 | - | ns |
| TE to CP Set-up Time | t _{SU} | 4.5 | 40 | - | - | 50 | - | 60 | - | ns |
| P to CP Hold Time | t _H | 4.5 | 5 | - | - | 5 | - | 5 | - | ns |
| TE to CP Hold Time | t _H | 4.5 | 0 | - | - | 0 | - | 0 | - | ns |
| MR to CP Removal Time | t _{REM} | 4.5 | 10 | - | - | 13 | - | 15 | - | ns |
| PE to CP Hold Time | t _H | 4.5 | 2 | - | - | 2 | - | 2 | - | ns |

CD54HC40103, CD74HC40103, CD74HCT40103

Switching Specifications Input $t_r, t_f = 6\text{ns}$

| PARAMETER | SYMBOL | TEST CONDITIONS | V_{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|---|-------------------------|---------------------|-----------------|------|-----|-----|------------------|-----|-------------------|-----|-------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| HC TYPES | | | | | | | | | | | |
| Propagation Delay CP to any \overline{TC} (Async Preset) | $t_{PLH},$ t_{PHL} | $C_L = 50\text{pF}$ | 2 | - | - | 300 | - | 375 | - | 450 | ns |
| | | $C_L = 50\text{pF}$ | 4.5 | - | - | 60 | - | 75 | - | 90 | ns |
| | | $C_L = 15\text{pF}$ | 5 | - | 25 | - | - | - | - | - | ns |
| | | $C_L = 50\text{pF}$ | 6 | - | - | 51 | - | 64 | - | 77 | ns |
| CP to \overline{TC} (Sync Preset) | $t_{PLH},$ t_{PHL} | $C_L = 50\text{pF}$ | 2 | - | - | 300 | - | 375 | - | 450 | ns |
| | | $C_L = 50\text{pF}$ | 4.5 | - | - | 60 | - | 75 | - | 90 | ns |
| | | $C_L = 15\text{pF}$ | 5 | - | 25 | - | - | - | - | - | ns |
| | | $C_L = 50\text{pF}$ | 6 | - | - | 51 | - | 64 | - | 77 | ns |
| \overline{TE} to \overline{TC} | $t_{PLH},$ t_{PHL} | $C_L = 50\text{pF}$ | 2 | - | - | 200 | - | 250 | - | 300 | ns |
| | | $C_L = 50\text{pF}$ | 4.5 | - | - | 40 | - | 50 | - | 60 | ns |
| | | $C_L = 15\text{pF}$ | 5 | - | 17 | - | - | - | - | - | ns |
| | | $C_L = 50\text{pF}$ | 6 | - | - | 34 | - | 43 | - | 51 | ns |
| \overline{PL} to \overline{TC} | $t_{PLH},$ t_{PHL} | $C_L = 50\text{pF}$ | 2 | - | - | 275 | - | 345 | - | 415 | ns |
| | | $C_L = 50\text{pF}$ | 4.5 | - | - | 55 | - | 69 | - | 83 | ns |
| | | $C_L = 15\text{pF}$ | 5 | - | 23 | - | - | - | - | - | ns |
| | | $C_L = 50\text{pF}$ | 6 | - | - | 47 | - | 59 | - | 71 | ns |
| \overline{MR} to \overline{TC} | $t_{PLH},$ t_{PHL} | $C_L = 50\text{pF}$ | 2 | - | - | 275 | - | 345 | - | 415 | ns |
| | | $C_L = 50\text{pF}$ | 4.5 | - | - | 55 | - | 69 | - | 83 | ns |
| | | $C_L = 15\text{pF}$ | 5 | - | 23 | - | - | - | - | - | ns |
| | | $C_L = 50\text{pF}$ | 6 | - | - | 47 | - | 59 | - | 71 | ns |
| Output Transition Time | t_{TLH}, t_{THL} | $C_L = 50\text{pF}$ | 2 | - | - | 75 | - | 95 | - | 110 | ns |
| | | $C_L = 50\text{pF}$ | 4.5 | - | - | 15 | - | 19 | - | 22 | ns |
| | | $C_L = 50\text{pF}$ | 6 | - | - | 13 | - | 16 | - | 19 | ns |
| Input Capacitance | C_i | $C_L = 50\text{pF}$ | - | - | - | 10 | - | 10 | - | 10 | pF |
| CP Maximum Frequency | f_{MAX} | $C_L = 15\text{pF}$ | 5 | - | 25 | - | - | - | - | - | MHz |
| Power Dissipation Capacitance (Notes 4, 5) | C_{PD} | - | 5 | - | 25 | - | - | - | - | - | pF |
| HCT TYPES | | | | | | | | | | | |
| Propagation Delay CP to \overline{TC} (Async Preset) | $t_{PLH},$ t_{PHL} | $C_L = 50\text{pF}$ | 4.5 | - | - | 60 | - | 75 | - | 90 | ns |
| | | $C_L = 15\text{pF}$ | 5 | - | 25 | - | - | - | - | - | ns |
| \overline{CE} to \overline{TC} (Sync Preset) | $t_{PLH},$ t_{PHL} | $C_L = 50\text{pF}$ | 4.5 | - | - | 63 | - | 79 | - | 95 | ns |
| | | $C_L = 15\text{pF}$ | 5 | - | 26 | - | - | - | - | - | ns |
| \overline{TE} to \overline{TC} | $t_{PLH},$ t_{PHL} | $C_L = 50\text{pF}$ | 4.5 | - | - | 50 | - | 63 | - | 75 | ns |
| | | $C_L = 15\text{pF}$ | 5 | - | 21 | - | - | - | - | - | ns |
| \overline{PL} to \overline{TC} | $t_{PLH},$ t_{PHL} | $C_L = 50\text{pF}$ | 4.5 | - | - | 68 | - | 85 | - | 102 | ns |
| | | $C_L = 15\text{pF}$ | 5 | - | 28 | - | - | - | - | - | ns |

CD54HC40103, CD74HC40103, CD74HCT40103

Switching Specifications Input $t_r, t_f = 6\text{ns}$ (Continued)

| PARAMETER | SYMBOL | TEST CONDITIONS | V_{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|--|--------------------|---------------------|--------------|------|-----|-----|---------------|-----|----------------|-----|-------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| \overline{MR} to \overline{TC} | t_{PLH}, t_{PHL} | $C_L = 50\text{pF}$ | 4.5 | - | - | 55 | - | 69 | - | 83 | ns |
| | | $C_L = 15\text{pF}$ | 5 | - | 23 | - | - | - | - | - | ns |
| Output Transition Time | t_{THL}, t_{TLH} | $C_L = 50\text{pF}$ | 4.5 | - | - | 15 | - | 19 | - | 22 | ns |
| Input Capacitance | C_{IN} | $C_L = 50\text{pF}$ | - | - | - | 10 | - | 10 | - | 10 | pF |
| CP Maximum Frequency | f_{MAX} | $C_L = 15\text{pF}$ | 5 | - | 25 | - | - | - | - | - | MHz |
| Power Dissipation Capacitance (Notes 4, 5) | C_{PD} | - | 5 | - | 27 | - | - | - | - | - | pF |

NOTES:

- Noncascaded operation only. With cascaded counters clock-to-terminal count propagation delays, count enables (\overline{PE} or \overline{TE})-to-clock SET UP TIMES, and count enables (\overline{PE} or \overline{TE})-to-clock HOLD TIMES determine maximum clock frequency. For example, with these HC devices:

$$C_P f_{MAX} = \frac{1}{\text{CP-to-}\overline{TC} \text{ prop delay} + \overline{TE}\text{-to-CP Setup Time} + \overline{TE}\text{-to-CP Hold Time}} = \frac{1}{60 + 30 + 0} \approx 11\text{MHz}$$

- C_{PD} is used to determine the dynamic power consumption, per package.
- $P_D = V_{CC}^2 f_i + C_L V_{CC}^2 f_o$ where f_i = Input Frequency, C_L = Output Load Capacitance, V_{CC} = Supply Voltage, f_o = Output Frequency.

Timing Diagrams

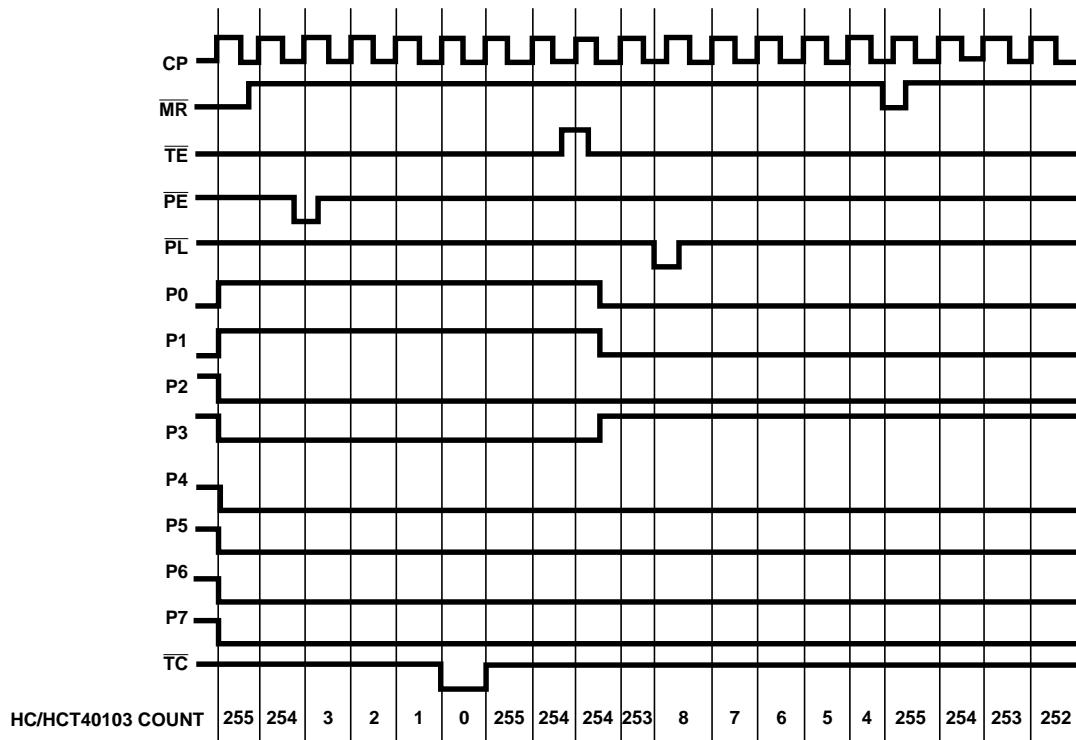


FIGURE 1.

CD54HC40103, CD74HC40103, CD74HCT40103

Test Circuits and Waveforms

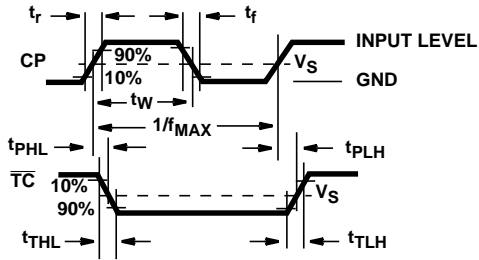


FIGURE 2.

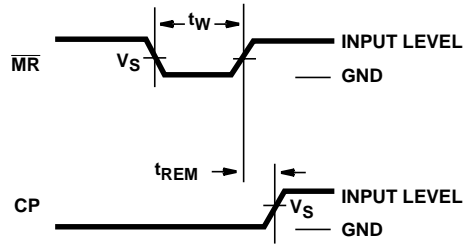


FIGURE 3.

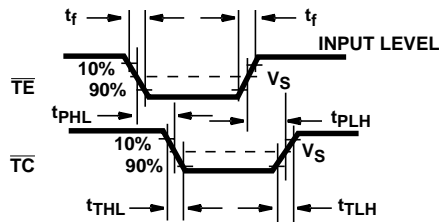


FIGURE 4.

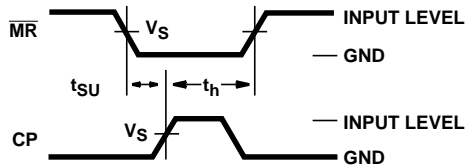


FIGURE 5.

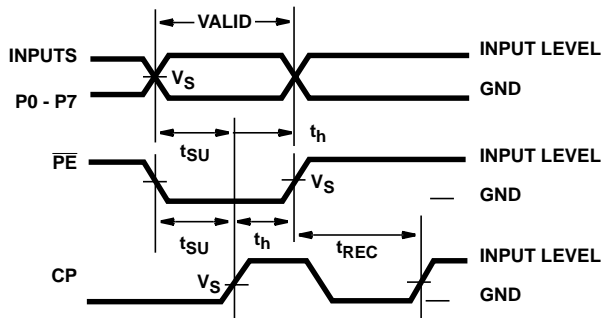


FIGURE 6.

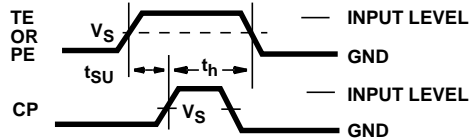
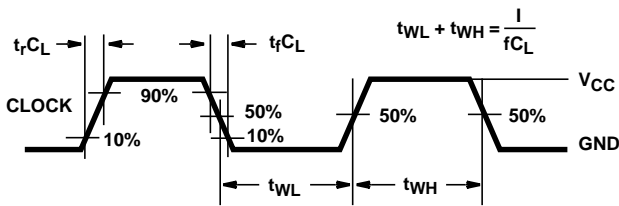
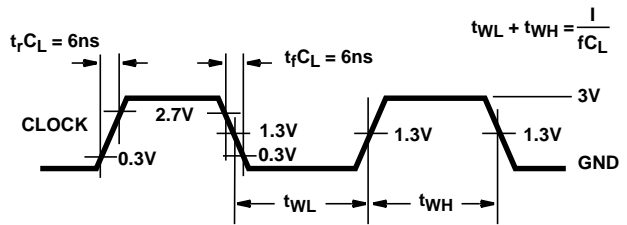


FIGURE 7.



NOTE: Outputs should be switching from 10% V_{CC} to 90% V_{CC} in accordance with device truth table. For f_{MAX} , input duty cycle = 50%.

FIGURE 8. HC CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH



NOTE: Outputs should be switching from 10% V_{CC} to 90% V_{CC} in accordance with device truth table. For f_{MAX} , input duty cycle = 50%.

FIGURE 9. HCT CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|-------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 5962-9055301EA | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| 5HC40103F3AS228 | OBSOLETE | CDIP | J | 16 | | TBD | Call TI | Call TI |
| CD54HC40103F | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| CD54HC40103F3A | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| CD74HC40103E | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| CD74HC40103EE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| CD74HC40103M | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD74HC40103M96 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD74HC40103M96E4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD74HC40103ME4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD74HC40103MT | ACTIVE | SOIC | D | 16 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD74HC40103MTE4 | ACTIVE | SOIC | D | 16 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD74HCT40103E | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| CD74HCT40103EE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| CD74HCT40103M | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD74HCT40103M96 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD74HCT40103M96E4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD74HCT40103ME4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD74HCT40103MT | ACTIVE | SOIC | D | 16 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD74HCT40103MTE4 | ACTIVE | SOIC | D | 16 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

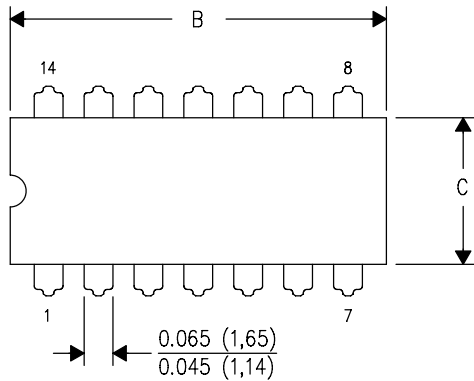
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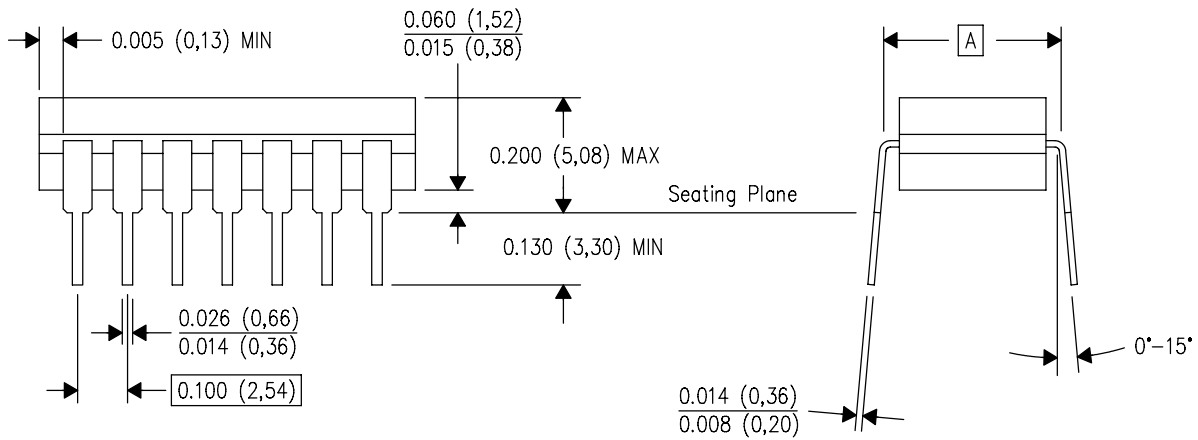
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14 | 16 | 18 | 20 |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC |
| B MAX | 0.785 (19,94) | .840 (21,34) | 0.960 (24,38) | 1.060 (26,92) |
| B MIN | — | — | — | — |
| C MAX | 0.300 (7,62) | 0.300 (7,62) | 0.310 (7,87) | 0.300 (7,62) |
| C MIN | 0.245 (6,22) | 0.245 (6,22) | 0.220 (5,59) | 0.245 (6,22) |



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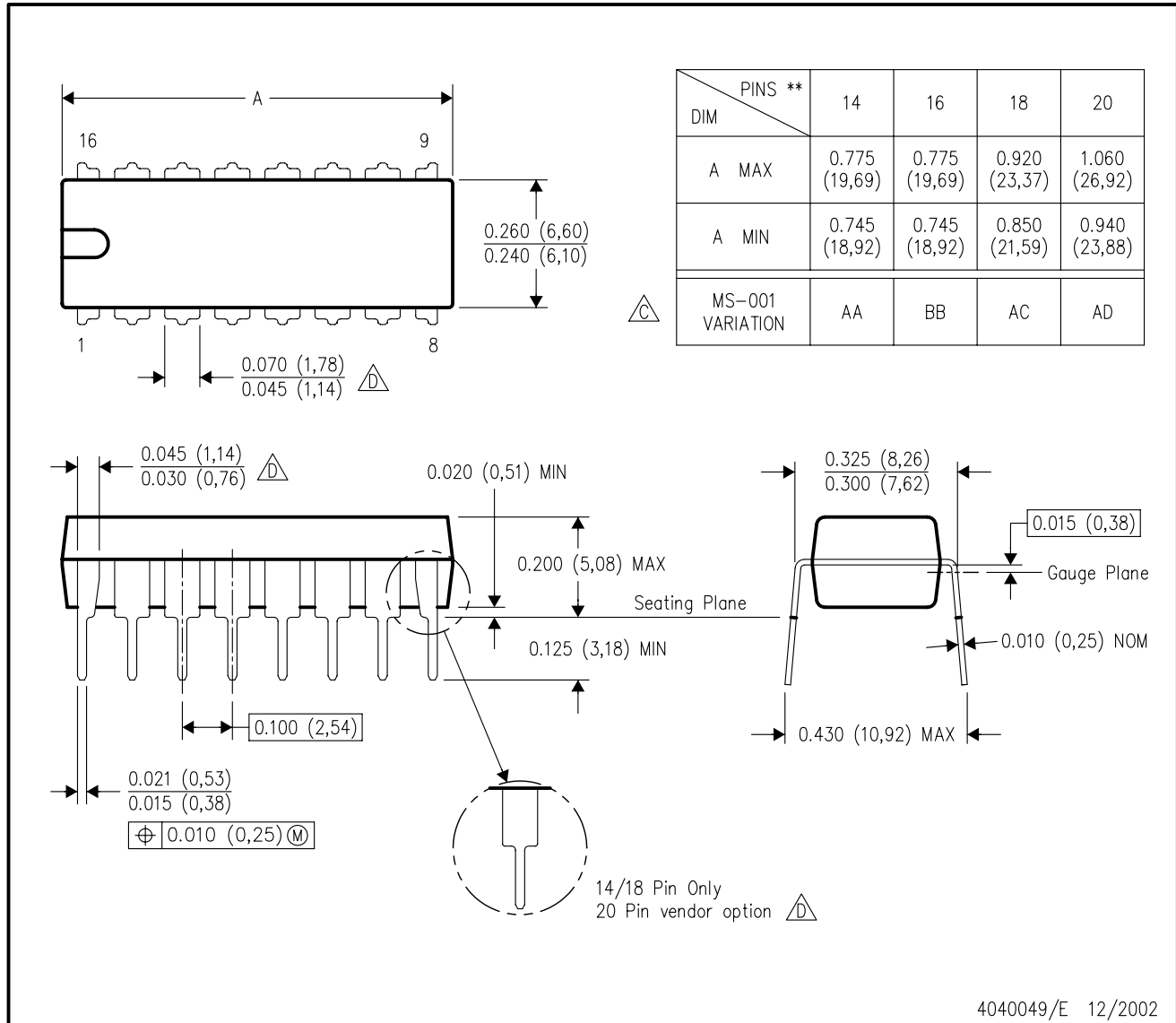
- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MECHANICAL DATA

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE

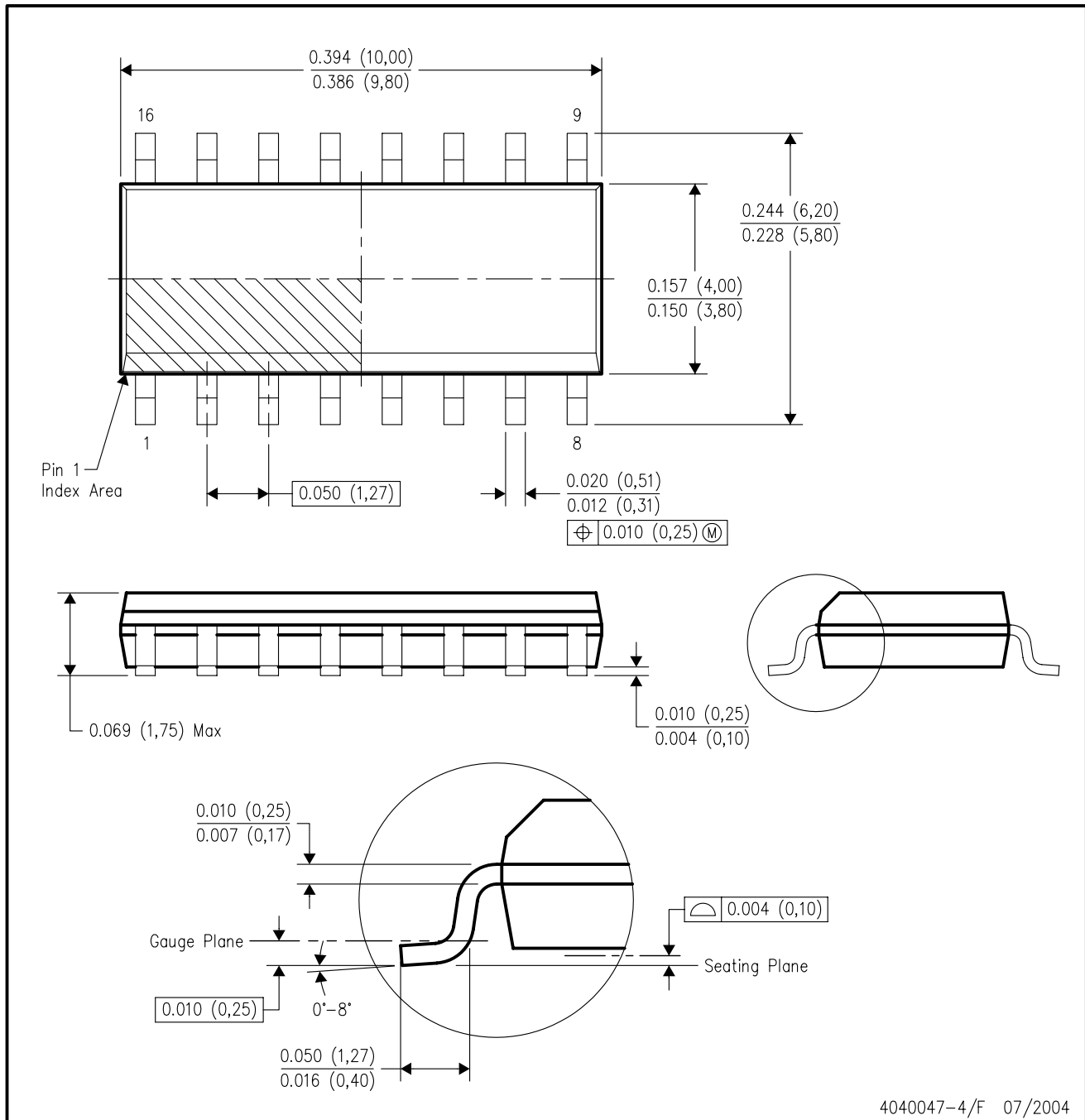


- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - $\triangle D$ The 20 pin end lead shoulder width is a vendor option, either half or full width.

MECHANICAL DATA

D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MS-012 variation AC.

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